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#### **Features**

- Ultra-low-pressure ranges from 25 to 500 Pa (0.1 to 2 inH<sub>2</sub>O)
- Pressure sensor based on thermal microflow measurement
- High flow impedance
- · very low flow-through leakage
- high immunity to dust and humidity
- no loss in sensitivity using long tubing
- Calibrated and temperature compensated
- Unique offset autozeroing feature ensuring superb long-term stability
- Offset accuracy better than 0.2% FS
- Total accuracy better than 0.5% FS typical
- On-chip temperature sensor
- Analog output and digital SPI interface
- No position sensitivity

#### Certificates

- Quality Management System according to EN ISO 13485 and EN ISO 9001
- · RoHS and REACH compliant

#### Media compatibility

Air and other non-corrosive gases

# LDE SERIES – DIGITAL LOW DIFFERENTIAL PRESSURE SENSORS

The LDE differential low-pressure sensors are based on thermal flow measurement of gas through a micro-flow channel integrated within the sensor chip. The innovative LDE technology features superior sensitivity especially for ultra-low pressures. The extremely low gas flow through the sensor ensures high immunity to dust contamination, humidity and long tubing compared to other flow-based pressure sensors.

#### **Applications**

#### Medical

- Ventilators
- Spirometers
- CPAP
- Sleep diagnostic equipment
- Nebulizers
- Oxygen conservers/concentrators
- Insufflators/endoscopy

#### Industrial

- HVAC
- VAV
- Filter monitoring
- Burner control
- Fuel cells
- Gas leak detection
- Gas metering
- Fume hood
- Instrumentation
- Security systems

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## Maximum ratings

Parameter		Min.	Max.	Unit
Supply voltage V	LDExxx3xxx	2.70	3.60	.,
Supply voltage V <sub>S</sub>	LDExxx6xxx	4.75	5.25	V <sub>DC</sub>
Output current			1	mA
Soldering recommendation				
Reflow soldering (1,2)	•		·	
Average preheating temperature gradient			1.5	K/s
Time above 217 °C			74	_
Time above 240 °C			30	S
Peak temperature			245	°C
Cooling temperature gradient			-1.4	K/s
Wave soldering, pot temperature			260	°C
Hand soldering, tip temperature			370	-0
Temperature ranges				
Compensated		0	+70	
Operating		-20	+80	°C
Storage		-40	+80	
Humidity limits (nin-condensing)			97	%RH
Vibration (3)			20	_
Mechanical shock (4)			500	g

### Pressure sensor characteristics

Part no.	Operating pressure	Proof pressure (5)	Burst pressure (5)
LDES025Uxxx	0 to 25 Pa / 0 to 0.25 mbar (0.1 inH2O)		
LDES050Uxxx	0 to 50 Pa / 0 to 0.5 mbar (0.2 inH2O)		
LDES100Uxxx	0 to 100 Pa / 0 to 1 mbar (0.4 inH2O)		
LDES250Uxxx	0 to 250 Pa / 0 to 2.5 mbar (1 inH2O)		
LDES500Uxxx	0 to 500 Pa / 0 to 5 mbar (2 inH2O)	2 bar	5 bar
LDES025Bxxx	0 to ±25 Pa / 0 to ±0.25 mbar (±0.1 inH2O)	(30 psi)	(75 psi)
LDES050Bxxx	0 to ±50 Pa / 0 to ±0.5 mbar (±0.2 inH2O)		
LDES100Bxxx	0 to ±100 Pa / 0 to ±1 mbar (±0.4 inH2O)		
LDES250Bxxx	0 to ±250 Pa / 0 to ±2.5 mbar (±1 inH2O)		
LDES500Bxxx	0 to ±500 Pa / 0 to ±5 mbar (±2 inH2O)		

## Gas correction factors (6)

Gas type	Correction factor
Dry air	1.0
Oxygen (O <sub>2</sub> )	1.07
Nitrogen (N <sub>2</sub> )	0.97
Argon (Ar)	0.98
Carbon dioxide (CO <sub>2</sub> )	0.56

## LDExxx6xxx Performance characteristics (7)

 $(V_S=5.0\ V_{DC},\ T_A=20\ ^{\circ}C,\ P_{Abs}=1\ bara,\ calibrated\ in\ air,\ analog\ and\ digital\ output\ signals\ are\ non-ratiometric\ to\ V_S)$ 

#### 25 Pa and 50 Pa devices

Parameter	Min.	Typ.	Max.	Unit
Noise level (RMS)		±0.01		Pa
Offset warm-up shift			less than noise	
Offset long term stability (8)		±0.05	±0.1	Pa/year
Offset repeatability		±0.01		Pa
Span repeatability (11,12)		±0.25		% of reading
Current consumption (no load) (9)		7	8	mA
Response time (t <sub>63</sub> )		5		ms
Power-on time			25	ms

#### **Digital output**

Parameter			Min.	Тур.	Max.	Unit
Cools factor (digital output) (10)	0 to 25/0 to	±25 Pa		1200		counts/Pa
Scale factor (digital output) (10)	0 to 50/0 to	±50 Pa		600		counts/Pa
Zero pressure offset accuracy <sup>(11)</sup>				±0.1	±0.2	%FSS
Span accuracy (11,12)				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±0.2	%FSS
Thermal effects		0 to 70 °C			±0.4	%FSS
mermai ellecis	Span	5 to 55 °C		±1	±1.75	% of reading
		0 to 70 °C		±2	±2.75	% of reading

### Analog output (unidirectional devices)

Parameter			Min.	Тур.	Max.	Unit
Zero pressure offset <sup>(11)</sup>			0.49	0.50	0.51	٧
Full scale output				4.50		٧
Span accuracy <sup>(11,12)</sup>				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±15	mV
Thermal effects		0 to 70 °C			±30	mV
	0	5 to 55 °C		±1.25	±2	% of reading
	Span	0 to 70 °C		±2	±2.75	% of reading

#### Analog output (bidirectional devices)

Parameter		Min.	Тур.	Max.	Unit	
Zero pressure offset <sup>(11)</sup>			2.49	2.50	2.51	V
Output	at max. s	specified pressure		4.50		V
Output	at min. specified pressure			0.50		V
Span accuracy <sup>(11,12)</sup>	Span accuracy <sup>(11,12)</sup>			±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±15	mV
Thermal effects		0 to 70 °C			±30	mV
mermai enecis	Span	5 to 55 °C		±1.25	±2	% of reading
		0 to 70 °C		±2	±2.75	% of reading

### LDExxx6xxx Performance characteristics (cont.) (7)

 $(V_S=5.0\ V_{DC},\ T_A=20\ ^{\circ}C,\ P_{Abs}=1\ bara,\ calibrated\ in\ air,\ analog\ and\ digital\ output\ signals\ are\ non-ratiometric\ to\ V_S)$ 

#### 100 Pa, 250 Pa and 500 Pa devices

Parameter	Min.	Тур.	Max.	Unit
Noise level (RMS)		±0.01		%FSS
Offset warm-up shift			less than noise	
Offset long term stability (8)		±0.05	±0.1	%FSS/year
Offset repeatability (13)		±0.02		Pa
Span repeatability (11,12)		±0.25		% of reading
Current consumption (no load) (9)		7	8	mA
Response time (t <sub>63</sub> )		5		ms
Power-on time			25	ms

#### **Digital output**

Parameter			Min.	Тур.	Max.	Unit
	0 to 100/0	to ±100 Pa		300		
Scale factor (digital output) (10)	0 to 250/0	to ±250 Pa		120		counts/Pa
	0 to 500/0	0 to 500/0 to ±500 Pa		60		
Zero pressure offset accuracy (11)	Zero pressure offset accuracy (11)			±0.05	±0.1	%FSS
Span accuracy (11,12)				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±0.1	%FSS
Thermal effects		0 to 70 °C			±0.2	%FSS
Thermal effects		5 to 55 °C		±1	±1.75	% of reading
	Span	0 to 70 °C		±2	±2.75	% of reading

#### Analog output (unidirectional devices)

Parameter			Min.	Typ.	Max.	Unit
Zero pressure offset (11)			0.49	0.50	0.51	V
Full scale output				4.50		V
Span accuracy (11, 12)				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±10	mV
Thermal effects	Oliset	0 to 70 °C			±12	mV
mermai enects	Cnan	5 to 55 °C		±1	±1.75	% of reading
	Span	0 to 70 °C		±2	±2.75	% of reading

#### **LDE SERIES - DIGITAL LOW DIFFERENTIAL PRESSURE SENSORS**

#### Analog output (bidirectional devices)

Parameter			Min.	Тур.	Max.	Unit
Zero pressure offset (11)			2.49	2.50	2.51	V
Output	at max.	specified pressure		4.50		V
Output	at min. specified pressure			0.50		V
Span accuracy (11,12)	Span accuracy (11,12)			±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±10	mV
Thermal effects		0 to 70 °C			±12	mV
	Span	5 to 55 °C		±1	±1.75	% of reading
		0 to 70 °C		±2	±2.75	% of reading

## LDExxx3xxx Performance characteristics (7)

 $(V_S=3.0\ V_{DC},\ T_A=20\ ^{\circ}C,\ P_{Abs}=1\ bara,\ calibrated\ in\ air,\ analog\ and\ digital\ output\ signals\ are\ non-ratiometric\ to\ V_S)$ 

#### 25 Pa and 50 Pa devices

Parameter	Min.	Тур.	Max.	Unit
Noise level (RMS)		±0.01		Pa
Offset warm-up shift			less than noise	
Offset long term stability (8)		±0.05	±0.1	Pa/year
Offset repeatability		±0.01		Pa
Span repeatability (11,12)		±0.25		% of reading
Current consumption (no load) (9)		14	16	mA
Response time (t <sub>63</sub> )		5		ms
Power-on time			25	ms

#### **Digital output**

Parameter			Min.	Typ.	Max.	Unit
Scale factor (digital output) (10)	0 to 25/0 to	±25 Pa		1200		counts/Pa
- Ocale factor (digital output)	0 to 50/0 to ±50 Pa			600		counts/Pa
Zero pressure offset accuracy (11)				±0.1	±0.2	%FSS
Span accuracy (11,12)				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±0.2	%FSS
Thermal effects		0 to 70 °C			±0.4	%FSS
memai enecis	Span	5 to 55 °C		±1	±1.75	% of reading
		0 to 70 °C		±2	±2.75	% of reading

#### Analog output (unidirectional devices)

Parameter			Min.	Тур.	Max.	Unit
Zero pressure offset (11)			0.29	0.30	0.31	V
Full scale output				2.70		V
Span accuracy (11,12)				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±15	mV
Thermal effects	Oliset	0 to 70 °C			±30	mV
mermai ellects	Cnon	5 to 55 °C		±1.25	±2	% of reading
	Span	0 to 70 °C		±2	±2.75	% of reading

#### Analog output (bidirectional devices)

Parameter			Min.	Тур.	Max.	Unit
Zero pressure offset (11)			1.49	1.50	1.51	V
Output	at max. s	specified pressure		2.70		V
Output	at min. specified pressure			0.30		V
Span accuracy (11,12)	Span accuracy (11,12)			±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±15	mV
Thermal effects		0 to 70 °C			±30	mV
	Cnon	5 to 55 °C		±1.25	±2	% of reading
	Span	0 to 70 °C		±2	±2.75	% of reading

### LDExxx3xxx Performance characteristics (cont.) (7)

(V<sub>S</sub>=3.0 V<sub>DC</sub>, T<sub>A</sub>=20 °C, P<sub>Abs</sub>=1 bara, calibrated in air, analog and digital output signals are non-ratiometric to V<sub>S</sub>)

#### 100 Pa, 250 Pa and 500 Pa devices

Parameter	Min.	Тур.	Max.	Unit
Noise level (RMS)		±0.01		%FSS
Offset warm-up shift			less than noise	
Offset long term stability (8)		±0.05	±0.1	%FSS/year
Offset repeatability (13)		±0.02		Pa
Span repeatability (11,12)		±0.25		% of reading
Current consumption (no load) (9)		14	16	mA
Response time (t <sub>63</sub> )		5		ms
Power-on time			25	ms

### Digital output

Parameter			Min.	Тур.	Max.	Unit
	0 to 100/0	to ±100 Pa		300		
Scale factor (digital output) (10)	0 to 250/0	0 to 250/0 to ±250 Pa		120		counts/Pa
	0 to 500/0	0 to 500/0 to ±500 Pa		60		
Zero pressure offset accuracy (11)			±0.05	±0.1	%FSS	
Span accuracy (11,12)				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±0.1	%FSS
Thermal effects	Oliset	0 to 70 °C			±0.2	%FSS
	Span	5 to 55 °C		±1	±1.75	% of reading
	Орап	0 to 70 °C		±2	±2.75	% of reading

### Analog output (unidirectional devices)

Parameter			Min.	Тур.	Max.	Unit
Zero pressure offset (11)			0.29	0.30	0.31	V
Full scale output				2.70		V
Span accuracy (11,12)				±0.4	±0.75	% of reading
	04	5 to 55 °C			±10	mV
Thermal effects	Offset	0 to 70 °C			±12	mV
r nermai ellecis	Span	5 to 55 °C		±1	±1.75	% of reading
	Span	0 to 70 °C		±2	±2.75	% of reading

### Analog output (bidirectional devices)

Parameter			Min.	Тур.	Max.	Unit
Zero pressure offset (11)			1.49	1.50	1.51	V
Output	at max. s	specified pressure		2.70		V
Output	at min. specified pressure			0.30		V
Span accuracy (11,12)				±0.4	±0.75	% of reading
	Offset	5 to 55 °C			±10	mV
Thermal effects		0 to 70 °C			±12	mV
	Span	5 to 55 °C		±1	±1.75	% of reading
		0 to 70 °C		±2	±2.75	% of reading

### Performance characteristics

#### Temperature sensor

Parameter	Min.	Тур.	Max.	Unit
Scale factor (digital output)		95		counts/°C
Non-linearity		±0.5		%FS
Hysteresis		±0.1		%FS

## Total accuracy (14)

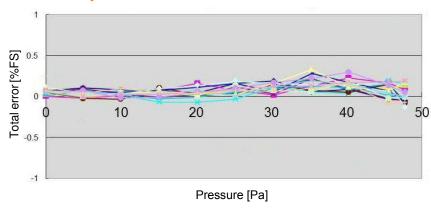


Fig. 1: Typical total accuracy plot of 16 LDE 50 Pa sensors @ 25 °C (typical total accuracy better than 0.5 %FS)

### Offset long term stability

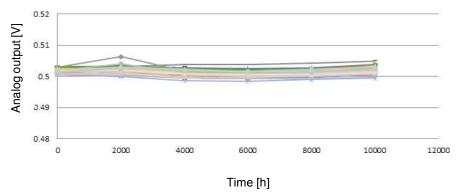


Fig. 2: Offset long term stability for LDE 250 Pa sensors after 10,000 hours @  $85^{\circ}$ C powered, equivalent to over 43.5 years @  $25^{\circ}$ C (better than  $\pm 2$  mV /  $\pm 0.125$  Pa)

#### SPI - Serial Peripheral Interface

Note: it is important to adhere to the communication protocol in order to avoid damage to the sensor.

#### Introduction

The LDE serial interface is a high-speed synchronous data input and output communication port. The serial interface operates using a standard 4-wire SPI bus. The LDE device runs in SPI mode 0, which requires the clock line SCLK to idle low (CPOL = 0), and for data to be sampled on the leading clock edge (CPHA = 0). Figure 5 illustrates this mode of operation.

Care should be taken to ensure that the sensor is properly connected to the master microcontroller. Refer to the manufacturer's datasheet for more information regarding physical connections.

#### **Application circuit**

The use of pull-up resistors is generally unnecessary for SPI as most master devices are configured for push-pull mode. If pull-up resistors are required for use with 3 V LDE devices, however, they should be greater than 50 k $\Omega$ .

There are, however, some cases where it may be helpful to use  $33\Omega$  series resistors at both ends of the SPI lines, as shown in Figure 3.

Signal quality may be further improved by the addition of a buffer as shown in Figure 4. These cases include multiple slave devices on the same bus segment, using a master device with limited driving capability and long SPI bus lines.

If these series resistors are used, they must be physically placed as close as possible to the pins of the master and slave devices.

#### Signal control

The serial interface is enabled by asserting /CS low. The serial input clock, SCLK, is gated internally to begin accepting the input data at MOSI or sending the output data on MISO. When /CS rises, the data clocked into MOSI is loaded into an internal register.

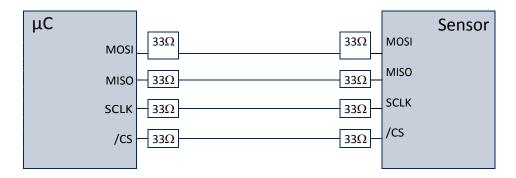


Fig. 3: Application circuit with resistors at both ends of the SPI lines

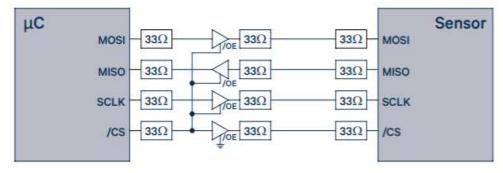


Fig. 4: Application circuit with additional buffer

#### SPI - Serial Peripheral Interface (cont.)

Note: it is important to adhere to the communication protocol in order to avoid damage to the sensor.

#### Data read - pressure

When powered on, the sensor begins to continuously measure pressure. To initiate data transfer from the sensor, the following three unique bytes must be written sequentially, MSB first, to the MOSI pin (see Figure 5):

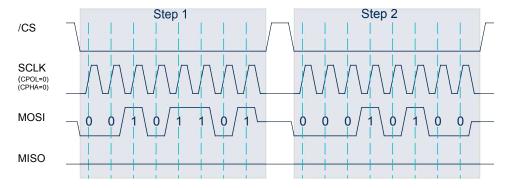
Step	Hexadecimal	Binary	Description
1	0x2D	B00101101	Poll current pressure measurement
2	0x14	B00010100	Send result to data register
3	0x98	B10011000	Read data register

The entire 16 bit content of the LDE register is then read out on the MISO pin, MSB first, by applying 16 successive clock pulses to SCLK with /CS asserted low. Note that the value of the LSB is held at zero for internal signal processing purposes. This is below the noise threshold of the sensor and thus its fixed value does not affect sensor performance and accuracy.

From the digital sensor output the actual pressure value can be calculated as follows:

Pressure [Pa] = 
$$\frac{\text{Digital output [counts]}}{\text{Scale factor } \left[ \frac{\text{counts}}{\text{Pa}} \right]}$$

For example, for a ±250 Pa sensor (LDES250Bxxx) with a scale factor of 120 a digital output of 30 000 counts (7530'h) calculates to a positive pressure of 250 Pa. Similarly, a digital output of -30 000 counts (8AD0'h) calculates to a negative pressure of -250 Pa.



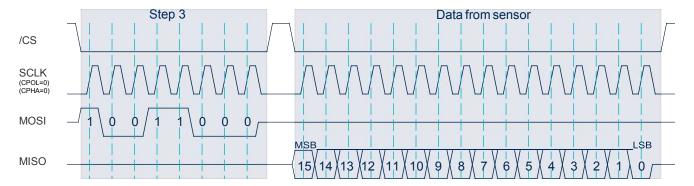


Fig. 5: SPI data transfer

### SPI - Serial Peripheral Interface (cont.)

#### Data read - temperature

The on-chip temperature sensor changes 95 counts/°C over the operating range. The temperature data format is 15-bit plus sign in two's complement format. To read temperature, use the following sequence:

Step	Hexadecimal	Binary	Description
1	0x2A	B00101010	Poll current temperature measurement
2	0x14	B00010100	Send result to data register
3	0x98	B10011000	Read data register

From the digital sensor output, the actual temperature can be calculated as follows

Temperature [°C] = 
$$\frac{TS - TS_0 \text{ [counts]}}{Scale factor_{TS} \left[\frac{counts}{^{\circ}C}\right]} + T_0[^{\circ}C]$$

#### where

TS is the actual sensor readout; TS $_0$  is the sensor readout at known temperature T $_0$  (15); Scale factor TS = 95 counts/°C

## SPI – Serial Peripheral Interface (cont.)

### Interface specification

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
External clock frequency	f <sub>ECLK</sub>	V <sub>CKSEL</sub> =0 Min.		0.2		MHz
	·EOLK	Max.		5		
External master clock input low time	f <sub>ECLKIN LO</sub>	t <sub>ECLK</sub> =1/f <sub>ECLK</sub>	40		60	%t <sub>ECLK</sub>
External master clock input high time	f <sub>ECLKIN HI</sub>	t <sub>ECLK</sub> =1/f <sub>ECLK</sub>	40		60	
SCLK setup to falling edge /CS	t <sub>SC</sub>		30			ns
/CS falling edge to SCLK rising edge setup time	t <sub>css</sub>		30			110
/CS idle time	t <sub>CSI</sub>	f <sub>CL</sub> K=4 MHz	1.5			μs
SCLK falling edge to data valid delay	t <sub>DO</sub>	C <sub>LOAD</sub> =15 pF			80	
Data valid to SCLK rising edge setup time	t <sub>DS</sub>		30			
Data valid to SCLK rising edge hold time	t <sub>DH</sub>		30			
SCLK high pulse width	t <sub>CH</sub>		100			ns
SCLK low pulse width	t <sub>CL</sub>		100			
/CS rising edge to SCLK rising edge hold time	t <sub>CSH</sub>		30		25	
/CS falling edge to output enable	t <sub>DV</sub>	C <sub>LOAD</sub> =15 pF				
/CS rising edge to output disable	t <sub>TR</sub>	C <sub>LOAD</sub> =15 pF			25	
Lxxx6xxx (5 V supply)						
Maximum output load capacitance	C <sub>LOAD</sub>	R <sub>LOAD</sub> =∞, phase margin >55°		200		pF
Input voltage, logic HIGH	V <sub>IH</sub>		0.8×V <sub>S</sub>		V <sub>S</sub> +0.3	
Input voltage, logic LOW	$V_{IL}$				0.2×V <sub>S</sub>	
		R <sub>LOAD</sub> =∞	V <sub>S</sub> - 0.1			V
Output voltage, logic HIGH	V <sub>OH</sub>	$R_{LOAD}$ =2 k $\Omega$	V <sub>S</sub> - 0.15			
Output voltage, logic LOW	.,	R <sub>LOAD</sub> =∞			0.5	
	V <sub>OL</sub>	R <sub>LOAD</sub> =2 kΩ			0.2	
LDExxx3xxx (3 V supply) (16)						
Maximum output load capacitance	C <sub>LOAD</sub>	R <sub>LOAD</sub> =1 kΩ		15		pF
Input voltage, logic HIGH	V <sub>IH</sub>		0.65xV <sub>S</sub>		VS+0.3	
Input voltage, logic LOW	V <sub>IL</sub>				0.35×V <sub>S</sub>	
Output voltage, logic HIGH	V <sub>OH</sub>	Ι <sub>0</sub> =-20 μΑ	V <sub>S</sub> - 0.4			V
Output voltage, logic LOW	V <sub>OL</sub>	I <sub>O</sub> =+20 μA			0.4	
	•					

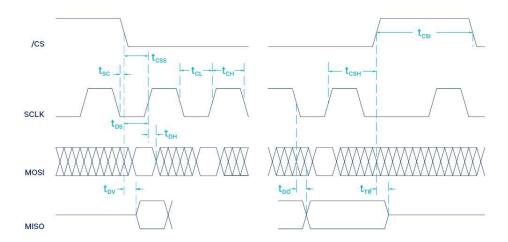
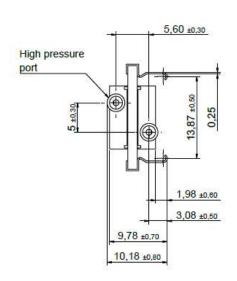
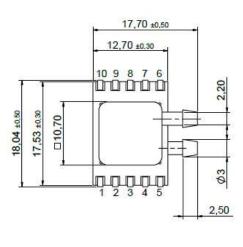


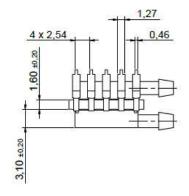
Fig. 6: SPI timing diagram

### **Dimensional drawing**

- LDExxxExxx (SMD, 2 ports same side)







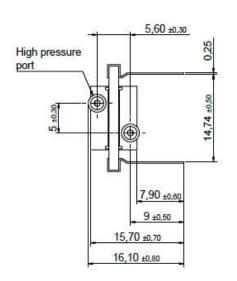


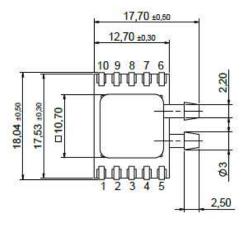
all dimension in mm

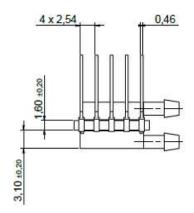
all tolerances 0,10mm unless otherwise noted

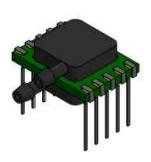
## **Dimensional drawing**

LDExxxFxxx (DIP, 2 ports same side)



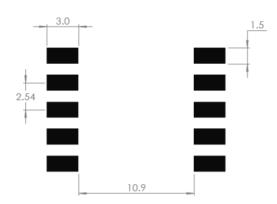






all dimension in mm all tolerances 0,10mm unless otherwise noted

### Recommended PCB footprint for LDExxxExxx



dimensions in mm measurements without tolerance are for reference only

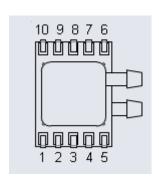
### Electrical connection (17)

There are three use cases that will change the manner in which the LDE series device is connected in-circuit:

Case 1: Reading of pressure measurement as a digital (SPI) signal;

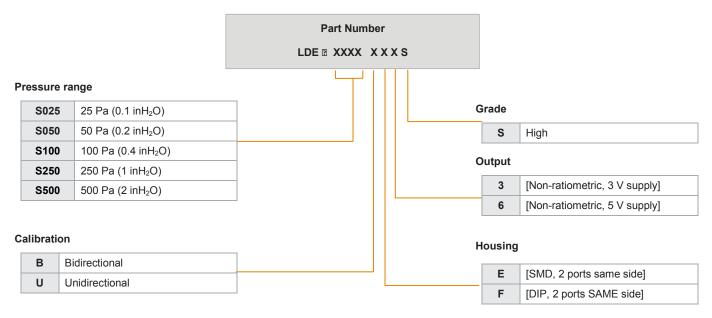
Case 2: Reading of pressure measurement as an analog (voltage) signal;

Case 3: Pin-to-pin compatible drop-in replacement for LBA series devices (5 V LDE devices only).



Pin	Function	Case 1: Digital signal output	Case 2: Analog signal output	Case 3: LBA drop-in replacement (5 V only)
1	Reserved	NC	NC	GND
2	V <sub>s</sub>	+5V/+3V	+5V/+3V	+5V
3	GND	GND	GND	GND
4	Vout	NC	High impedance	High impedance analog
5	Vout	NC	analog input (e.g. op- amp, ADC)	input (e.g. op-amp, ADC)
6	SCLK	Master device SCLK	GND	GND
7	MOSI	Master device MOSI	GND	GND
8	MISO	Master device MISO	GND	GND
9	/CS	Master device (/CS)	V <sub>s</sub>	GND
10	Reserved	NC	NC	GND

### Part numbering key



Order code example: LDES250BF6S

### Ordering information (standard configurations)

Description	TE Part Number	Pressure Range	Calibration	Housing	Output
LDES250UF6S	1006941-F	0 to 250 Pa	Unidirectional	[DIP, 2 ports SAME side]	6V
LDES500UE3S	5000659-F	0 to 500 Pa	Unidirectional	[SMD, 2 ports same side]	3V
LDES100UF6S	1006939-F	0 to 100 Pa	Unidirectional	[DIP, 2 ports SAME side]	6V
LDES500BF6S	5000658-F	-500 Pa to 500 Pa	Bidirectional	[DIP, 2 ports SAME side]	6V
LDES250UE3S	5000652-F	0 to 250 Pa	Unidirectional	[SMD, 2 ports same side]	3V
LDES500UF6S	1006943-F	0 to 500 Pa	Unidirectional	[DIP, 2 ports SAME side]	6V
LDES300UE3S	5000655-F	0 to 300 Pa	Unidirectional	[SMD, 2 ports same side]	3V